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Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RE: U.S. Patent Application No. 10/574,783  
Inventor: Kitamura, et al.  
Filed: April 6, 2006  
For: Semiconductive Film, Electric Charge Control Member and Process for Producing the Semiconductive Film  
Docket No. NISH.0001US (361131.00001)

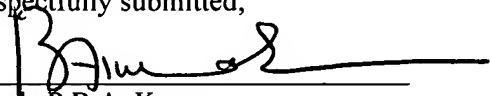
Dear Sir:

Enclosed for filing in connection with the above-referenced patent application are the following documents:

1. Response to Office Communication;
2. Self addressed stamped return receipt postcard.

Please charge any other fee required and/or credit any over charge with respect to this response to Deposit Account No. 18-0586.

Respectfully submitted,

  
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Attorney for Applicant

**EXPRESS MAIL CERTIFICATE (37 CFR 1.10)**

Express Mail Label No. EV831188991US

Date of Deposit: August 13, 2009

I hereby certify that this paper, and the papers and/or fees referred to herein as transmitted, submitted or enclosed, are being deposited with the U.S. Postal Service "Express Mail Post Office to Addressee" service under 37 CFR § 1.10 on the date indicated above and is addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Name: Amol Purohit

Signature 